Multilayer silicene: clear evidence of Ag-terminated bulk silicon
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To cite this version:
Alberto Curcella, Romain Bernard, Yves Borensztein, Michele Lazzeri, Andrea Resta, et al.. Multilayer silicene: clear evidence of Ag-terminated bulk silicon. 2D Materials, IOP Publishing, 2017, 4, pp.25067-25067. 10.1088/2053-1583/aa65b8. hal-01505617

HAL Id: hal-01505617
https://hal.sorbonne-universite.fr/hal-01505617
Submitted on 11 Apr 2017

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The existence of silicite, a new allotrope of silicon based on a stacking of hexagonal silicene planes is one of the most discussed topic in the field of 2D materials. Using grazing incidence X-ray diffraction (GIXD), we have followed in situ the growth of Si films on Ag(111) in the low temperature growth regime (510 - 520 K). GIXD experiments demonstrate that Si films have a diamond-like structure, with an averaged lattice constant slightly different from bulk Si. The diffracted intensities associated with the Si films are well reproduced by the Ag/Si(111) \((\sqrt{3} \times \sqrt{3})R30^\circ\) honeycomb chain model, whereas models with Ag-free Si surfaces fail to reproduce the experimental data.

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Recent years have shown an increasing interest in two-dimensional (2D) atomic layers, like graphene, silicene, germanene or phosphorene, metal dichalcogenides or trichalcogenides, or boron nitrides, which display very peculiar and promising properties [1,2]. Whereas many of these 2D materials can be obtained by exfoliation of the bulk material, this is not the case for silicene, the graphene counterpart for silicon, since no graphite analogue exists for silicon. However, it has been shown theoretically that a self-standing single layer of silicene is a metastable structure, [3–5] the binding energy of Si atoms in silicene being 0.76 eV higher than in Si bulk.[5]

Epitaxial silicene layers have been first observed on Ag(111). (4×4), (\(\sqrt{3} \times \sqrt{3}\))R13.9° and (2\(\sqrt{3} \times 2\sqrt{3}\))R30° structures have been found to coexist on the surface, with a relative proportion depending on the preparation conditions.[6–9] All those structures exhibit a buckled hexagonal organization,[10] with a buckling depending on the matching between the Si and Ag lattices. We recall that (4×4), (\(\sqrt{3} \times \sqrt{3}\))R13.9° and (2\(\sqrt{3} \times 2\sqrt{3}\))R30° refers to reconstructions with respect to the Ag(111) surface. With respect to a free-standing silicene plane, the (4×4) phase corresponds to a (3×3) reconstruction, whereas the (\(\sqrt{3} \times \sqrt{3}\))R13.9° and (2\(\sqrt{3} \times 2\sqrt{3}\))R30° phases, to various (\(\sqrt{3} \times \sqrt{3}\))R19.1° reconstructions. The structure and properties of these single layers are still investigated [11–14].

Above a coverage \(\theta_{Si}=1\) monolayer (ML), a new reconstruction forms, with an apparent \(\left(4/\sqrt{3} \times 4/\sqrt{3}\right)\) unit cell with respect to the Ag(111) substrate [15–19]. In the following, 1 ML corresponds to the saturation of the (4×4) layer, i.e. 18/16 of the atomic density of a Ag(111)
plane. This is only 0.8% less than the atomic density of a Si(111) double plane in bulk silicon. The \( \left( \frac{4}{\sqrt{3}} \times \frac{4}{\sqrt{3}} \right) \) reconstruction remains visible even for 16 ML deposits. Relatively to the silicene plane, it corresponds to a \( \left( \sqrt{3} \times \sqrt{3} \right) R_{30^\circ} \) reconstruction.

These thick Si/Ag(111) films have been firstly described as a new class of material, silicite, the equivalent of graphite for silicon atoms. This conclusion was supported by the fact that (i) the \( \left( \sqrt{3} \times \sqrt{3} \right) R_{30^\circ} \) reconstruction does not exist on a clean Si(111) surface, (ii) the Raman signature of these thick Si films is different from the one of Si(111), and (iii) the Si interlayer spacing is 1% smaller than in the Si bulk. Atomic models based on density functional theory (DFT) calculations have been proposed as alternatives of the classical diamond structure of Si, showing pseudo-layered materials with an interlayer spacing of 0.495 nm or 0.429 nm. Models have been also proposed for the \( \left( \sqrt{3} \times \sqrt{3} \right) R_{30^\circ} \) reconstruction of a silicene layer, based on the initial attribution of this structure to a silicene single layer, and for freestanding and Ag(111)-supported silicene bilayers. However, these results have been put into questions by further experimental studies performed by independent groups. Low-energy electron diffraction (LEED) experiments have been performed on Si thick films grown at \( T_{\text{growth}} = 500 \) K. It was shown that the experimental data could not be explained by proposed models that only considered buckling of the Si atoms, instead a good agreement was obtained by considering a thin film of bulklike silicon terminated with the Ag/Si \( \left( \sqrt{3} \times \sqrt{3} \right) R_{30^\circ} \) surface. The same conclusion was put forward on the basis of a comparison between STM measurements performed on Si/Ag(111) and on Ag/Si(111) films in the 473K-623K temperature range, and by our own experimental results: from Auger electron spectroscopy (AES) and optical reflectance measurements, we have shown that the optical response of thick (>10 layers) Si/Ag(111) films grown at \( T_{\text{growth}} = 473 \) K or 503 K was similar to the one of diamond-like bulk Si, and
that Ag atoms were segregated at the surface during growth.\cite{33} The ABC stacking of Si double planes, similar to the one of diamond-like Si has been also evidenced by STM,\cite{34} whereas the Ag termination of the surface has been confirmed by core-level photoemission spectroscopy (XPS) measurements ($T_{\text{growth}} = 503$ K),\cite{35} angle-resolved photoemission spectroscopy (ARPES) measurements ($473 \leq T_{\text{growth}} \leq 543$ K),\cite{36} metastable atom electron spectroscopy ($T_{\text{growth}} = 500$ K),\cite{37} and by deuterium exposure of the surface leading to the formation of Ag 3D islands ($450 \leq T_{\text{growth}} \leq 550$ K).\cite{38}

The exact structure and surface termination of the thin Si films is therefore still discussed. Although, from most of the experimental results, the \((\sqrt{3} \times \sqrt{3})R30^\circ\) reconstruction is interpreted as due to the presence of Ag atoms at the surface, a reconstruction involving only silicon atoms has been put forward on the basis of scanning tunneling spectroscopy (STS) measurements\cite{34} and STM measurements during peeling of the surface at 77 K.\cite{39} Models for a Ag free - \((\sqrt{3} \times \sqrt{3})R30^\circ\) reconstruction of Si diamond-like films have been proposed on the basis of DFT calculations.\cite{40,41} Other differences between Si/Ag(111) films and Ag/Si(111) have been also underlined: it was observed that, whereas for Ag/Si(111) a phase transition is observed at 150 K between the honeycomb-chained triangle (HCT) structure and the inequivalent triangle (IET) structure,\cite{42} a phase transition is observed at much lower temperature on Si/Ag(111), namely at 40 K.\cite{25,34}

In a recent publication, De Padova et al. propose a new interpretation of the experimental discrepancies observed between the different groups\cite{43}. Using \textit{ex situ} energy dispersive grazing incidence x-ray diffraction (ED-GIXD), De Padova et al. have measured the lattice constant of 10 ML thick Si films grown at either 473 K or 573 K. Diamond-like Si is observed after growth at $T_{\text{growth}} = 573$ K. Instead, after growth at $T_{\text{growth}} = 473$ K, the diffraction pattern shows that the in-plane lattice constant of the Si film is 6.477Å, i.e. 2.7%
lower than the value found for the \((\sqrt{3} \times \sqrt{3})R30^\circ\) reconstruction of Ag/Si(111) (6.655 Å). In their measurements, the out-of-plane lattice constant displays also a weaker contraction, in the order of 1.5%. They conclude that the crystal structure of the Si film differs from the one of diamond and that multilayer silicene forms for low temperature growth, whereas deposition at higher temperatures leads to the formation of 3D Si crystallites. The \((\sqrt{3} \times \sqrt{3})R30^\circ\) structure observed would thus be different for the two cases. Whereas it would correspond to the Ag/Si\((\sqrt{3} \times \sqrt{3})R30^\circ\) reconstruction for high temperature growth, it would be intrinsic to the pristine silicene multilayer for low temperature growth.

Indeed, it has been shown that the mode of growth and the structure of silicene single and multi-layers depend strongly on the temperature during deposition.\([7,8,44,45]\) The \((4 \times 4)\) and \((\sqrt{3} \times \sqrt{3})R13.9^\circ\) silicene phases preferentially form at low temperature, whereas the \((2\sqrt{3} \times 2\sqrt{3})R30^\circ\) phase is generally seen for growth at \(T_{\text{growth}} > 540\text{K}\.\)\([8,7,6]\) This latter temperature also corresponds to a transition observed during multilayer growth. In fact, above \(T_{\text{growth}} = 540\text{K},\) the growth of the second silicon layer is accompanied by a dewetting of the first layer, leading to the recovery of bare Ag surface regions.\([8,38,39,46]\) On the contrary, the silicene monolayer does not dewet below \(T_{\text{growth}} = 540\text{K},\) but is progressively replaced by the growing film. \([17,19,20,33]\)

Thus, if, following De Padova and collaborators, one assumes that there exist a transition temperature for the structure of thick Si films grown on Ag(111), it is reasonable to assign this temperature to the transition temperature \(T_c = 540\text{K}\) above which the \((2\sqrt{3} \times 2\sqrt{3})R30^\circ\) silicene phase forms and dewets upon further growth. However, open questions remain on the exact nature of the Si films, formed at low temperature, which are claimed to be multilayer silicene. De Padova et al. have determined the lattice constants of the films, but their atomic structure remains unknown.\([20,43]\) The origin of the differences observed by Raman and X-
ray diffraction (XRD) between Si/Ag films and bulk Si [20] is also not fully understood, and no structural model for a Ag-free $\left(\sqrt{3} \times \sqrt{3}\right)R30^\circ$ reconstruction has been experimentally validated.

Using grazing incidence X-ray diffraction (GIXD), we have followed the in situ growth of Si films on Ag(111) in the low temperature growth regime (510 - 520 K). The GIXD experiments demonstrate that Si films have a diamond-like structure, therefore unambiguously rejecting the existence of a new allotrope of Si for the growth of Si/Ag(111). The diffracted intensities associated with the Si films are well reproduced by the Ag/Si(111) HCT model, whereas models with Ag-free Si surfaces fail to reproduce the experimental data. Furthermore we measure an exhaustive set of Bragg reflections related to a diamond symmetry group $Fd3m$.

**Atomic structure of a thick Si film**

For $T_{\text{growth}} = 520K$, we have previously observed by GIXD that 1 ML evaporation leads to the preferential formation of the $(4 \times 4)$ silicene structure, with a small fraction of $(\sqrt{13} \times \sqrt{13})R13.9^\circ$ domains.[10] In the present study, we have grown, at the same temperature, a thicker Si deposit, namely 8 ML, as estimated from surface differential reflectance spectroscopy measurements. We have verified, during growth, that only $(4 \times 4)$ and $(\sqrt{13} \times \sqrt{13})R13.9^\circ$ reconstructions were visible below 1 ML coverage. After growth, a good agreement for the film thickness is found with x-ray reflectivity measurements, that can be fitted with a mean film thickness of 10.2 ML and a roughness of 1 ML.

Fig. 1 shows various maps of the diffracted intensity after Si deposition. Crystal truncation rods (CTR) at integer values for $h$ and $k$ correspond to the diffraction from the Ag interface, and the intense spots at $(10\bar{1})$, $(202)$, $(110)$, $(113)$, to the Bragg diffraction conditions for the
Ag crystal, in the surface unit cell coordinates. Other spots are visible and correspond to the diffraction from the silicon thin film. All these spots can be indexed with respect to a bulk diamond-like silicon film with (111) epitaxy. The diffraction spots from \{111\}, \{220\}, \{311\}, \{400\}, \{242\}, \{333\}, \{440\}, \{531\} planes indeed verify the non-extinction conditions for the diamond structure: \((h,k,l)\) are of same parity and \(h+k+l \neq 4n+2\). This demonstrates the diamond structure of the Si films and thus, we can reject any structure different from bulk silicon. Lastly, no signal can be seen at the position of the expected spots for the \((4 \times 4)\) and \((\sqrt{13} \times \sqrt{13})\)R13.9 structures, indicating that the silicene single layer is not preserved below the film that covers the whole surface, in good agreement with STM and LEED observations for thick Si/Ag(111) films prepared in similar conditions.[20,33]
Figure 1. Maps of the intensity diffracted by 8 ML Si evaporated on Ag(111) at $T_{\text{growth}} = 520 \text{K}$. Measurements are performed at the same temperature. a) for $k = 0$, b) for $h = k$. The color scale is the same for both maps. The indexed spots belong to diamond-like silicon with four orientations (corresponding to blue, red, green and black labels).
In these maps, four rotational domains are visible, corresponding to $[1\bar{1}0]_\text{Si} // [1\bar{1}0]_\text{Ag}$ or $[1\bar{1}0]_\text{Si} // [\bar{1}2\bar{1}]_\text{Ag}$ and ABC or ACB stacking for the successive Si double planes. Rods passing through these spots can be associated with the truncation of the Si films, whereas other rods faintly visible at $(h, k) \approx (0.25, 0.25)$ and $(h, k) \approx (0.5, 0.5)$ for the $[1\bar{1}0]_\text{Si} // [1\bar{1}0]_\text{Ag}$ epitaxy and at $(h, k) \approx (0.433, 0)$ and $(h, k) \approx (0.866, 0)$ for the $[1\bar{1}0]_\text{Si} // [\bar{1}2\bar{1}]_\text{Ag}$ epitaxy can be associated with the $(\sqrt{3} \times \sqrt{3})R30^\circ$ reconstruction of the Si surface. A wide azimuthal scan performed around the diffraction spot corresponding to $(3\bar{1}1)$ oriented Si planes is shown in Fig. 2. Various peaks are visible. We have fitted the signal with a combination of Voigt curves. Orientations of $0^\circ$, $1.08^\circ$, $10.91^\circ$, $25.32^\circ$, $26.54^\circ$, $30^\circ$ and their symmetrical with respect to $30^\circ$ are obtained from the fits. Similar observations can be made around the other diffraction conditions and confirm that all orientations correspond to diamond-like Si. Such observation of multi-domain orientation is similar to the one found by LEED by Salomon et al.: angles of $3^\circ$, $24.8^\circ$ and $30^\circ$ were measured after growth at 510 K.[19]

Figure 2. $\omega -$scan or azimuthal scan at a constant wave vector transfer corresponding to the diffraction by Si $(3\bar{1}1)$ planes. The ticks on the top axis indicates the position of the fitted peaks.
From the position of various diffraction spots, we have precisely measured the lattice constants of the Si diamond-like film which is not commensurable with the Ag surface. Whereas the ratio of the lattice constants for the Ag surface and the \((4 \times 4)\) silicene layer is exactly 3/4, at this deposition temperature (520 K), the ratio measured for the film is 0.759±0.001. This indicates a relaxation towards a smaller Si in-plane lattice constant when silicene transforms into bulk silicon. The Ag lattice constant at 520 K is 4.102 Å. [47] The measured Si lattice at 520 K is thus 5.407±0.007 Å. At this temperature, bulk silicon should have a lattice constant of 5.435 Å.[48] and our measured constant corresponds thus to a 0.5% contraction. Once the sample has been cooled down at room temperature, an identical small contraction is observed. The lattice constant of 5.399±0.005 Å measured at 300 K is associated with a contraction of 0.6% with respect to the lattice constant of bulk silicon (5.431 Å). We have measured the same value for all the orientations. This contraction is similar, although three times smaller, to the one observed by De Padova et al. for deposition at a lower temperature (470 K).

We have also obtained, at the deposition temperature, the out-of-plane lattice constant for the Si film by measuring the position along the \(l\) axis of various diffraction spots. Values have been corrected for the refraction of the incoming beam through the Si film. From the position of the \((3 \bar{1} 1)\) and \((3 \bar{3} 3)\) spots at \(l = l_{Si(111)} = 2.255\), a value of 3.140 ± 0.005 Å is measured for the silicon \((111)\) interplanar distance \(d_{Si(111)}\). This corresponds to the value expected for Si at this temperature. A nearly similar value, namely \(l_{Si(111)} = 2.241\), corresponding to \(d_{Si(111)} = 3.157\) Å is obtained from the distance along \(l\) between the \((1 \bar{1} 1)\) and \((202)\) spots and between the \((3 \bar{1} \bar{1})\) and \((400)\) spots (see Fig. 1).

However, contrary to what is expected for a perfect FCC stacking, the \((1 \bar{1} 1)\) and \((3 \bar{1} \bar{1})\) spots are not exactly at \(l = \frac{1}{3} l_{Si(111)}\) and the spots at \((202)\) and \((400)\) not exactly at
Taking as reference the value $I_{Si(111)}=2.241$ between two consecutive spots along the corresponding rods, we obtained that these spots display a positive shift $\delta=0.035$. Such shift can be associated to the presence of stacking faults in the films. Stacking faults have been shown to shift the positions of some diffraction peaks [49]. In particular, whereas spots at $l = nl_{(111)}$ are not shifted, spots at $l = (n+1/3)l_{(111)}$ are shifted towards higher values, and spots at $l = (n-1/3)l_{(111)}$ are shifted towards lower values. This is indeed what is measured here. From the value of $\delta$, an estimate of the stacking fault probability $p$ can be done. [50] Within the Paterson model (i.e. without correlation between faults),

$$\frac{\delta}{I_{Si(111)}} = \frac{1}{6} - \frac{1}{2\pi} \arctan \left( \sqrt{3}(1-2p) \right).$$

From this equation, we obtain that $p=0.1$, which corresponds to an average number of one stacking fault in the film, considering the mean film thickness.

Note that the measured shift could be also related to a non-negligible contribution of the surface reconstruction to the diffracted signal.

**Atomic structure of the $(\sqrt{3} \times \sqrt{3})R30^\circ$ reconstruction**

In a second step, we have grown, at $T_{growth}=510$ K, a 2 ML thick Si film. We have followed the evolution of the diffracted signal during growth. Fig. 3 shows the evolution with coverage $\theta_{Si}$ of the diffracted intensity near the (0.75,0.75,0.1) diffraction condition. Starting from a bare Ag surface, a peak corresponding to the $(4 \times 4)$ silicene superstructure is observed for coverage larger than 0.5 ML. This is in good agreement with previous STM observations showing that at low temperature, the small Si domains that form in the early stage of the growth are not ordered [51,45]. Between 0.5 ML and 1 ML, the signal increases...
abruptly, in relation with the transformation of disordered silicene regions into $(4 \times 4)$ domains.[45]

Figure 3. Evolution of the diffracted intensity for the $(0.75 \ 0.75 \ 0.15)$ position (red crosses) and the $(0.76 \ 0.76 \ 0.15)$ position (blue dots), during Si evaporation at $T_{growth} = 510$K.

Above 1 ML, a second peak is visible near $(0.76,0.76,0.15)$, corresponding to the growth of the Si film. The associated intensity grows linearly with coverage, while the diffracted intensity associated with the superstructure spots $(4 \times 4)$ decay slowly. This slow decay is in good agreement with LEEM observations at 491K.[8] We recall that for the thick 8 ML deposit, no signal could be seen for the $(0.75,0.75,0.15)$ position, indicating that the structure of the silicene single layer is not preserved below the film. The signal observed in the early stage of growth is thus related to parts of the surface which remain covered by the silicene single layer.

Fig. 4 shows the in-plane diffracted signal around the $(0.75,0.75,0.05)$ condition for 2 ML deposition. The spots corresponding to the $(4 \times 4)$ and $(\sqrt{13} \times \sqrt{13})$ reconstructions remains visible, which confirms that in this low temperature regime, there is no dewetting of the
silicene layer above 1 ML. The most intense spots correspond to the thin Si(111) film, with a main epitaxial relationship of 30° between the Si and Ag lattice, and the less intense spots, to other domains at ±4.3° from the main orientation. A wider, less intense, peak is also present at ±2.7°. More generally, we recover nearly the same orientations as the one found for the 8 ML film, excepted the orientation previously observed at 10.91°. From Fig. 4, it is clear that the Si(111) film has a lattice constant smaller than the one of silicene. At room temperature, we have measured, for the thin film, a Si lattice constant of 5.354±0.007Å, a value 1.4% smaller than the Si bulk lattice constant (5.431 Å). This reduction is twice the value found for the 8 ML film, which indicates that the in-plane lattice constant of the film depends on the thickness and/or on the small growth temperature difference (510 K vs 520 K). From the width of the Bragg spots of the Si film in the l direction, we obtain that the diffracting domains have an average thickness of 4 atomic diamond double planes. As the average deposited coverage is 2 ML, this indicates that the Si film is inhomogeneous, having regions with 1 ML and regions with a higher number of layers. This is confirmed by the observed small decay of the intensity diffracted by the (4×4) domains. Only a small fraction of the silicene monolayer has been converted to thicker islands, with a height distribution that is not directly accessible with GIXD. This is in good agreement with STM observations performed on 2.5 ML thick films grown at 490 K where Si islands with various heights coexist with the silicene layer at the surface of the Ag(111) sample.[17]
Fig. 4. in-plane map of the diffracted intensity near the (3/4,3/4) spot for \( l = 0.05 \), for 2 ML Si deposited at 510 K.

On this thin Si film, we have measured the structure factors associated with the \((\sqrt{3} \times \sqrt{3})R30^\circ\) reconstruction of the Si islands. For this purpose, we have performed, for in-plane conditions, standard rocking scans at \( l = 0.05 \) along several spots corresponding to the \((\sqrt{3} \times \sqrt{3})R30^\circ\) superstructure, and for "out of plane" conditions, standard rocking scans along four superstructure rods (SR), corresponding to \((h,k) \approx (0.254,0.254), \ (h,k) \approx (0.509,0.509), \) and \((h,k) \approx (1.27,1.27)\) and along two Si CTRs at \((h,k) \approx (0.763,0.763)\) and \((h,k) \approx (1.53,1.53)\). In the Si \((\sqrt{3} \times \sqrt{3})R30^\circ\) basis, these rods are indexed as \((10L), (20L), (30L), (50L)\)
and \((60L)\), with \(L = \frac{4}{3}l\). The standard instrumental correction was applied to the structure factors for taking into account the geometry of the diffractometer and the sample dimensions.[52]

The experimental structure factors have been further compared with simulated ones derived from the different models proposed in the literature. These models are the Ag-terminated honeycomb chain triangle model (HCT) [53], a similar model with Si trimers but without Ag atoms [31] (SiT), a model with Si vacancies (SiV), proposed in the past by Fan et al. for a \((\sqrt{3} \times \sqrt{3})R30^\circ\) reconstruction observed on pristine sputter-annealed Si(111) [54], the model of Guo and Oshiyama of a buckled hexagonal surface termination (Hex) [55], and models of surfaces terminated with one (TDS) or two (HDS) Si adatoms per unit cell, in dumbbell positions.[23] These different models are shown in Fig. 5.

For the calculation of structure factors, we have used the ROD program with Levenberg-Marquardt and simulated annealing procedures.[56] As free parameters, we have used two scale factors (for CTRs and superstructure rods respectively), Debye-Waller factors for the different layers, and in-plane and out-of-plane relaxations of all the atoms in the first three silicene layers, taking into account the symmetry of the models. The agreement between experimental \(F_{exp}\) and simulated \(F_{th}\) structure factors is estimated from the value of

\[
\chi^2 = \frac{1}{N_{pt} - N_{par}} \sum_{n} \left( \frac{F_{th} - F_{exp}}{\sigma_{exp}} \right)^2,
\]

where \(N_{pt} = 171\) is the number of experimental structure factors, and \(N_{par}\) the number of free parameters. The results of the fits are given in table 1.
Fig. 5. Schematic views (top and lateral) of the different atomistic models used for fitting the GIXD data (honeycomb chain triangle model, Si trimers, Si vacancies, buckled hexgonal, trigonal dumbbell structure and hexagonal dumbbell structure). Ag atoms are drawn in grey. For clarity, Si atoms of the top layer are drawn in orange, while the other Si atoms are drawn in yellow. For the HCT model, the atomic positions correspond to the best fit of the data, while they correspond to the starting positions for the fit for the other models.

Whereas a very good agreement, with $\chi^2 = 3.7$, is obtained with the HCT model, i.e. with a film surface similar to the $(\sqrt{3} \times \sqrt{3})R30^\circ$ reconstruction of Ag/Si(111), a very poor agreement is obtained with all other models, with $13.8 < \chi^2 < 25.4$. The comparison between experimental and simulated structure factors along the different rods is shown in Fig. 6 for the
best (HCT) model found and for the least worst (HDS) of the Ag-free models. While the intensity variations of the superstructure rods are well reproduced with the HCT model, the fit based on the HDS model gives a poor agreement and displays strong oscillations that are not observed experimentally. For the (30L) CTR rod, the peak at \( L = 3 \) reflects the FCC stacking of diamond-like silicon and is thus reproduced by the two models. The spurious oscillation visible at \( L = 1.5 \) on the fit of the latter mentioned for the HCT model is due to the interference pattern between the surface and the interface of the film. It would be suppressed by taking into account the distribution of film thicknesses. Finally, none of the Ag-free models are able to reproduce the high intensity of the (20L) rod at \( L = 0 \). This is easily explained by the fact that the atomic scattering factor \( f \) depends strongly on the atomic number. For example, for (200) diffraction condition, \( f_{Ag} = 39.8 \) whereas \( f_{Si} = 10.2 \). Thus, it is unrealistic to fit the experimental structure factors along the reconstruction rods with models that do not take into account the presence of Ag atoms.

<table>
<thead>
<tr>
<th>Model</th>
<th>( \chi^2 )</th>
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<tbody>
<tr>
<td>HCT [53]</td>
<td>3.7</td>
</tr>
<tr>
<td>SiT [57]</td>
<td>16.3</td>
</tr>
<tr>
<td>SiV [54]</td>
<td>25.4</td>
</tr>
<tr>
<td>Hex [55]</td>
<td>20.4</td>
</tr>
<tr>
<td>TDS [23]</td>
<td>18.0</td>
</tr>
<tr>
<td>HDS [23]</td>
<td>13.8</td>
</tr>
</tbody>
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Table 1: optimized \( \chi^2 \) for the various models of \((\sqrt{3} \times \sqrt{3})R30^\circ\) reconstruction.
Finally, we have simulated the diffracted intensities along several CTRs for a 8 ML film terminated with the HCT reconstruction. The comparison with the experimental results show that the (\(\sqrt{3} \times \sqrt{3}\))R30° reconstruction of the surface cannot by itself reproduce the observed shifts of the Si Bragg peaks, that must be thus attributed to stacking faults.

Fig. 6. Comparison between experimental (black dots) and simulated structure factors for three rods. Blue continuous line: HCT model, Red dotted line: HDS model.

**Discussion**

GIXD is a unique technique that allows to simultaneously measure, *in situ*, the structure of the bulk and the surface of a growing film. Whereas De Padova *et al.* have hypothesized the existence of a low temperature and a high temperature growth regime to explain the inconsistency between their results and the results of other groups, our observations demonstrate that, also for low temperature deposition conditions, i.e. for \(T_{\text{growth}} < 540\) K, the so-called "multilayer silicene" is in fact a thin diamond-like Si film terminated by the Ag/Si(111) \((\sqrt{3} \times \sqrt{3})R30°\) reconstruction. Thanks to the precision of present measurements, we can provide explanations for the difference observed between high and low temperature Si
growth. The Si crystal quality obviously depends on the growth temperature. Perfect Si nanocrystals are obtained for 573 K deposition,[43] with a lattice constant equal to the one of bulk Si. Note that this temperature corresponds also to the condition of a perfect Ag surfactant growth for the homoepitaxy of Si/Si(111).[58] At 510-520 K, we also observe the formation of diamond-like Si, but with a lattice constant smaller than the one of bulk Si. At 470 K, the lattice constant, measured by De Padova et al. is even smaller. Instead of being related to the formation of a new crystal structure, these lattice constant variations could be related to an increasing number of defects in the film structure as the growth temperature is lowered. At 510-520 K, from the shift of the Bragg reflections at $l = (n + 1/3)\nu_{(111)}$ and $l = (n - 1/3)\nu_{(111)}$, we have concluded to the presence of one stacking fault in average in the film. It has been also theoretically shown that the in-plane lattice constant of a Si film depends on the stacking sequence of the successive planes.[59] In particular, 10 ML thick Si films with wurtzite structure (ABAB) have a lattice constant 6% smaller than similar films with diamond structure (ABC). [59] Thus, the presence of stacking fault could explain the smaller in-plane lattice constant measured. Finally, these results allow us to propose another interpretation for the Raman signal measured by De Padova et al.[20,43]. Lattice contractions are expected to shift phonons to higher frequencies [60] therefore the +0.6% shift observed in the G band, with respect to the 520 cm$^{-1}$ bulk silicon can be assigned to the contracted silicon lattice present in the sample. The broad bands between 430 and 500 cm$^{-1}$ observed by De Padova et al. can instead be assigned to amorphous silicon which is known to have a very similar signature.[61]

Thus, upon those new experimental data and interpretation, there is no experimental evidence for the novel atomic organization of Si named silicite in thin Si/Ag epitaxial films. On the contrary, our results strongly suggest that an unique growth mechanism, i.e. the
surfactant role of Ag atoms, is responsible for the formation of Si diamond-like films in the 470 K-570 K temperature range on Ag(111).

METHODS

GIXD experiments have been performed on the SIXS beamline of SOLEIL synchrotron. The Ag(111) sample was prepared by repeated cycles of Ar\(^+\) sputtering and annealing at 800 K. Si was evaporated in the diffraction chamber (base pressure \(4.10^{-10}\) Torr) from a thermally heated crucible using a commercial Omicron Nanotechnology e-beam evaporator. From surface differential reflectance spectroscopy measurements, we estimated that the deposition rate was 1ML/2700s. The sample was analyzed with 18.46 keV X-rays at a grazing incidence angle of 0.145°. Diffracted X-rays were detected with a point detector. The \((h,k,l)\) indices used for indexing a reflection in reciprocal space refer to the Ag(111) surface basis \((a=b=2.889\text{Å}, c=7.075\text{Å}, \alpha=\beta=90^\circ, \gamma=120^\circ)\). The \((H,K,L)\) indices refer to the Si\((\sqrt{3}\times\sqrt{3})R30^\circ\) reconstruction with \((a=b=a_{\text{Si}}\sqrt{3}/2, c=a_{\text{Si}}\sqrt{3}, \alpha=\beta=90^\circ, \gamma=120^\circ)\).

ACKNOWLEDGMENTS

This work was supported by French state funds managed by the ANR within the Investissements d’Avenir program under Reference ANR-11-IDEX-0004-02 and more specifically within the framework of the Cluster of Excellence MATISSE. The SIXS beamline staff is greatly acknowledged for the technical support.

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